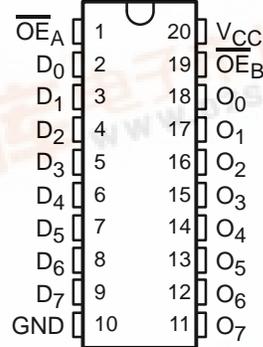


CY74FCT2541T 8-BIT BUFFER/LINE DRIVER WITH 3-STATE OUTPUTS

SCCS041B – SEPTEMBER 1994 – REVISED SEPTEMBER 2001

- **Function and Pinout Compatible With FCT and F Logic**
- **25-Ω Output Series Resistors to Reduce Transmission-Line Reflection Noise**
- **Reduced V_{OH} (Typically = 3.3 V) Versions of Equivalent FCT Functions**
- **Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics**
- **I_{off} Supports Partial-Power-Down Mode Operation**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- **Matched Rise and Fall Times**
- **Fully Compatible With TTL Input and Output Logic Levels**
- **12-mA Output Sink Current
15-mA Output Source Current**
- **3-State Outputs**

Q OR SO PACKAGE
(TOP VIEW)



description

The CY74FCT2541T is an octal buffer and line driver designed to be employed as a memory-address driver, clock driver, and bus-oriented transmitter/receiver. On-chip termination resistors at the outputs reduce system noise caused by reflections. The CY74FCT2541T can replace the CY74FCT541T to reduce noise in an existing design. The speed of the CY74FCT2541T is comparable to bipolar logic counterparts, while reducing power dissipation. Input and output voltage levels allow direct interface with TTL and CMOS devices without external components.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

T_A	PACKAGE†		SPEED (ns)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	QSOP – Q	Tape and reel	4.1	CY74FCT2541CTQCT	FCT2541C
		Tube	4.1	CY74FCT2541CTSOC	FCT2541C
	SOIC – SO	Tape and reel	4.1	CY74FCT2541CTSOCT	
		QSOP – Q	Tape and reel	4.8	CY74FCT2541ATQCT
	SOIC – SO		Tube	4.8	CY74FCT2541ATSOC
		SOIC – SO	Tape and reel	4.8	CY74FCT2541ATSOCT
	QSOP – Q		Tape and reel	8	CY74FCT2541TQCT
		SOIC – SO	Tube	8	CY74FCT2541TSOC
Tape and reel			8	CY74FCT2541TSOCT	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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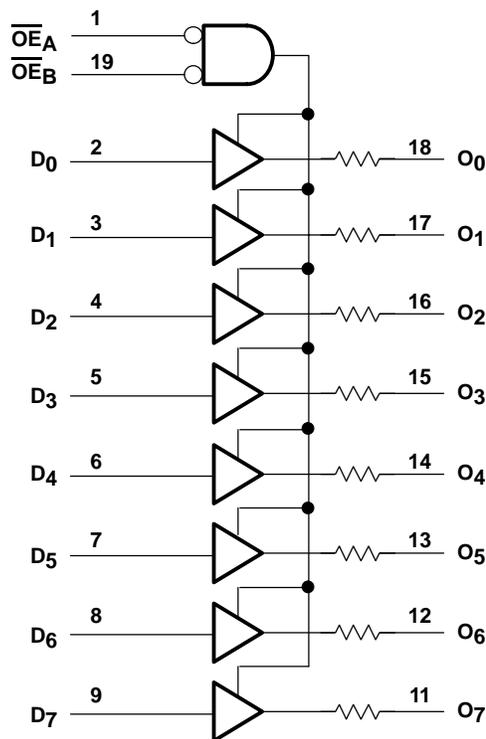
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FUNCTION TABLE

INPUTS			OUTPUT
\overline{OE}_A	\overline{OE}_B	D	
L	L	L	L
L	L	H	H
H	H	X	Z

H = High logic level, L = Low logic level,
X = Don't care, Z = High-impedance state

logic diagram (positive logic)



absolute maximum rating over operating free-air temperature range (unless otherwise noted)†

Supply voltage range to ground potential	–0.5 V to 7 V
DC input voltage range	–0.5 V to 7 V
DC output voltage range	–0.5 V to 7 V
DC output current (maximum sink current/pin)	120 mA
Package thermal impedance, θ_{JA} (see Note 1): Q package	68°C/W
SO package	58°C/W
Ambient temperature range with power applied, T_A	–65°C to 135°C
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
I_{OH}	High-level output current			-15	mA
I_{OL}	Low-level output current			12	mA
T_A	Operating free-air temperature	-40		85	°C

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V _{IK}	V _{CC} = 4.75 V,	I _{IN} = -18 mA		-0.7	-1.2	V
V _{OH}	V _{CC} = 4.75 V,	I _{OH} = -15 mA	2.4	3.3		V
V _{OL}	V _{CC} = 4.75 V,	I _{OL} = 12 mA		0.3	0.55	V
R _{out}	V _{CC} = 4.75 V,	I _{OL} = 12 mA	20	25	40	Ω
V _{hys}	All inputs			0.2		V
I _I	V _{CC} = 5.25 V,	V _{IN} = V _{CC}			5	μA
I _{IH}	V _{CC} = 5.25 V,	V _{IN} = 2.7 V			±1	μA
I _{IL}	V _{CC} = 5.25 V,	V _{IN} = 0.5 V			±1	μA
I _{OZH}	V _{CC} = 5.25 V,	V _{OUT} = 2.7 V			15	μA
I _{OZL}	V _{CC} = 5.25 V,	V _{OUT} = 0.5 V			-15	μA
I _{OS‡}	V _{CC} = 5.25 V,	V _{OUT} = 0 V	-60	-120	-225	mA
I _{off}	V _{CC} = 0 V,	V _{OUT} = 4.5 V			±1	μA
I _{CC}	V _{CC} = 5.25 V,	V _{IN} ≤ 0.2 V, V _{IN} ≥ V _{CC} - 0.2 V		0.1	0.2	mA
ΔI _{CC}	V _{CC} = 5.25 V, V _{IN} = 3.4 V§, f ₁ = 0, Outputs open			0.5	2	mA
I _{CCD¶}	V _{CC} = 5.25 V at 50% duty cycle, Outputs open, One bit switching, OE _A = OE _B = GND, V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} - 0.2 V			0.06	0.12	mA/MHz
I _{C#}	V _{CC} = 5.25 V, Outputs open, OE _A = OE _B = GND	One bit switching at f ₁ = 10 MHz, at 50% duty cycle	V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} - 0.2 V	0.7	1.4	mA
			V _{IN} = 3.4 V or GND	1	2.4	
		Eight bits switching at f ₁ = 2.5 MHz, at 50% duty cycle	V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} - 0.2 V	1.3	2.6	
			V _{IN} = 3.4 V or GND	3.3	10.6	
C _i				5	10	pF
C _o				9	12	pF

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

§ Per TTL-driven input (V_{IN} = 3.4 V); all other inputs at V_{CC} or GND

¶ This parameter is derived for use in total power-supply calculations.

I_C = I_{CC} + ΔI_{CC} × D_H × N_T + I_{CCD} (f₀/2 + f₁ × N₁)

Where:

I_C = Total supply current

I_{CC} = Power-supply current with CMOS input levels

ΔI_{CC} = Power-supply current for a TTL high input (V_{IN} = 3.4 V)

D_H = Duty cycle for TTL inputs high

N_T = Number of TTL inputs at D_H

I_{CCD} = Dynamic current caused by an input transition pair (HLH or LHL)

f₀ = Clock frequency for registered devices, otherwise zero

f₁ = Input signal frequency

N₁ = Number of inputs changing at f₁

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the I_{CC} formula.

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switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CY74FCT2541T		CY74FCT2541AT		CY74FCT2541CT		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	D	O	1.5	8	1.5	4.8	1.5	4.1	ns
t _{PHL}			1.5	8	1.5	4.8	1.5	4.1	
t _{PZH}	$\overline{\text{OE}}$	O	1.5	10	1.5	6.2	1.5	5.8	ns
t _{PZL}			1.5	10	1.5	6.2	1.5	5.8	
t _{PHZ}	$\overline{\text{OE}}$	O	1.5	9.5	1.5	5.6	1.5	5.2	ns
t _{PLZ}			1.5	9.5	1.5	5.6	1.5	5.2	

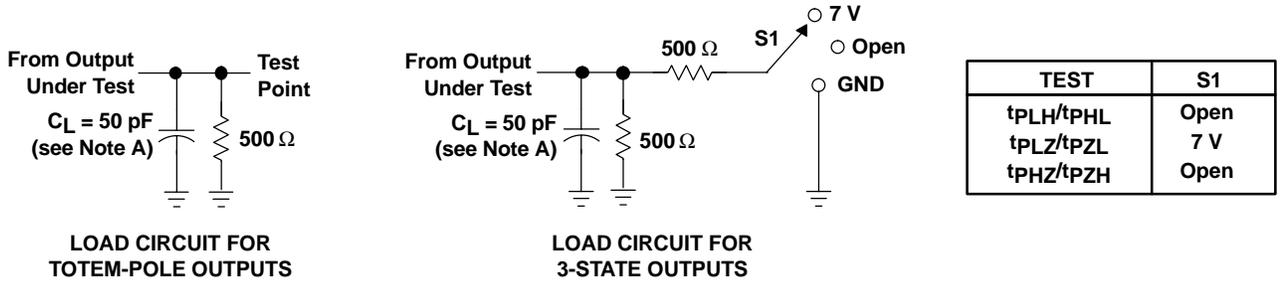
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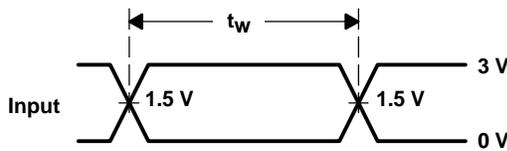
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PARAMETER MEASUREMENT INFORMATION

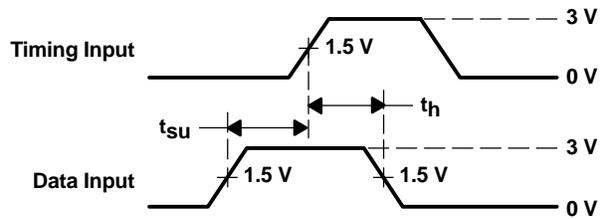


LOAD CIRCUIT FOR TOTEM-POLE OUTPUTS

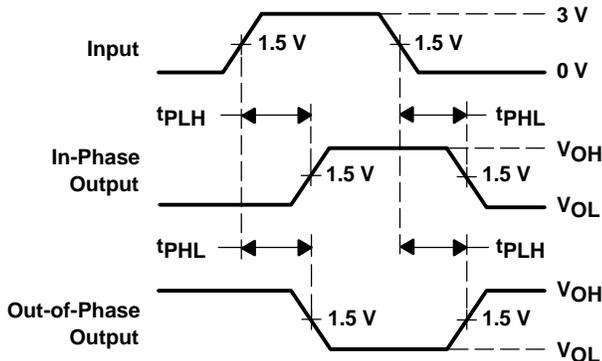
LOAD CIRCUIT FOR 3-STATE OUTPUTS



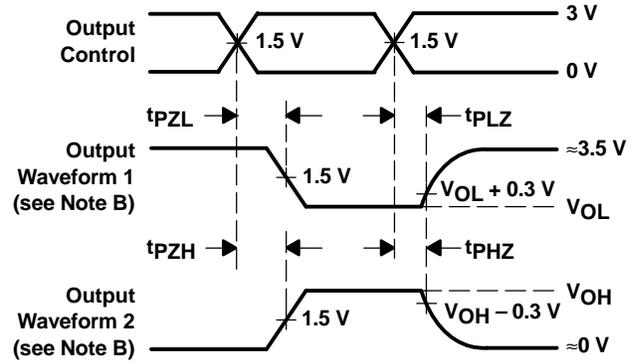
VOLTAGE WAVEFORMS PULSE DURATION



VOLTAGE WAVEFORMS SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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